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Low Power Peak EMI Reducing Solution

Features

- Generates an EMI optimized clock signal at the output.
- Integrated loop filter components.
- Operates with a 3.3 / 2.5V Supply.
- Operating current less than 4mA.
- Low power CMOS design.
- Input frequency range: 12MHz to 30MHz for 2.5V
 : 12MHz to 30MHz for 3.3V
- Generates a 1X low EMI spread spectrum clock of the input frequency.
- Spread Spectrum Enable Control.
- Frequency deviation: ±1% @ 24MHz
- Available in 6 pin TSOT-23, 8 pin SOIC and 8 pin TSSOP Packages.

Product Description

The ASM3P2579A is a versatile spread spectrum frequency modulator designed specifically for a wide range of clock frequencies. The ASM3P2579A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of all clock dependent signals. The ASM3P2579A allows significant system cost savings by reducing the number of circuit board layers ferrite beads, shielding that are traditionally required to pass EMI regulations.

The ASM3P2579A uses the most efficient and optimized modulation profile approved by the FCC and is implemented by using a proprietary all digital method.

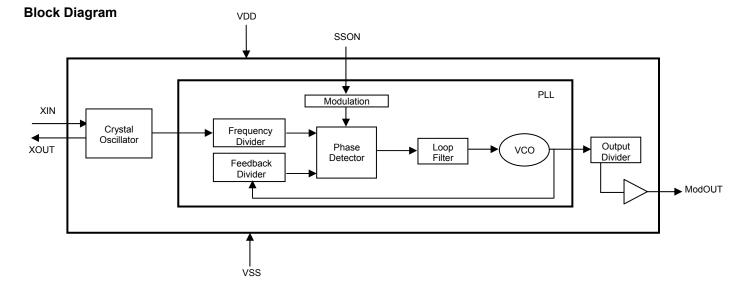
The ASM3P2579A modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called 'spread spectrum clock generation'.

Applications

The ASM3P2579A is targeted towards all portable devices with very low power requirements like MP3 players and digital still cameras.

Key Specifications

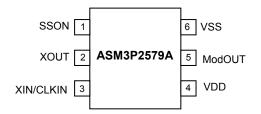
Description	Specification
Supply voltages	VDD = 3.3V/2.5V
Cycle-to-Cycle Jitter	200pS (Max)
Output Duty Cycle	45/55% (worst case)
Modulation Rate Equation	F _{IN} /640
Frequency Deviation	±1% @ 24MHz



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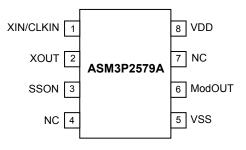
Pin Configuration (6-pin TSOT-23 Package)



Pin Description

Pin#	Pin Name	Туре	Description				
1	SSON	I	When SSON is HIGH, the spread spectrum is enabled and when LOW, it turns off the spread spectrum. Connect the pin to ground When Spread Spectrum feature is not required.				
2	XOUT	0	Crystal connection. If using an external reference, this pin must be left unconnected.				
3	XIN/CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.				
4	VDD	Р	Power supply for the entire chip				
5	ModOUT	0	Spread spectrum clock output.				
6	VSS	Р	Ground connection.				

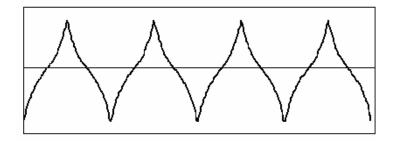
Pin Configuration (8-pin SOIC and TSSOP Packages)



Pin Description

Pin#	Pin Name	Туре	Description
1	XIN/CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.
2	XOUT	0	Crystal connection. If using an external reference, this pin must be left unconnected.
3	SSON	I	When SSON is HIGH, the spread spectrum is enabled and when LOW, it turns off the spread spectrum. Connect the pin to ground When Spread Spectrum feature is not required.
4	NC	-	No connect.
5	VSS	Р	Ground connection.
6	ModOUT	0	Spread spectrum clock output.
7	NC	-	No connect.
8	VDD	Р	Power supply for the entire chip

Modulation Profile



Specifications

Description	Specification		
Frequency Range	12MHz < CLKIN < 30MHz		
Modulation Equation	F _{IN} /640		
Frequency Deviation	±1% @ 24MHz		



Absolute Maximum Ratings

Parameter	Rating	Unit
Voltage on any pin with respect to Ground	-0.5 to +7.0	V
Storage temperature	-65 to +125	°C
Operating temperature	0 to 70	°C
Max. Soldering Temperature (10 sec)	260	°C
Junction Temperature	150	°C
Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	KV
	Voltage on any pin with respect to Ground Storage temperature Operating temperature Max. Soldering Temperature (10 sec) Junction Temperature Static Discharge Voltage	Voltage on any pin with respect to Ground-0.5 to +7.0Storage temperature-65 to +125Operating temperature0 to 70Max. Soldering Temperature (10 sec)260Junction Temperature150Static Discharge Voltage2

DC Electrical Characteristics for 2.5V Supply (Test condition: All parameters are measured at room temperature (+25°C) unless otherwise stated)

Symbol	Parameter	Min	Тур	Max	Unit		
V _{IL}	Input low voltage	VSS - 0.3	-	0.8	V		
V _{IH}	Input high voltage	2.0	-	VDD + 0.3	V		
IIL	Input low current	-	-	-35	μA		
IIн	Input high current	-	-	35	μA		
I _{XOL}	XOUT output low current (@0.5V, VDD=2.5V)	-	3	-	mA		
I _{XOH}	XOUT output high current (@1.8V, VDD=2.5V)	-	3	-	mA		
V _{OL}	Output low voltage (VDD = 2.5 V, I _{OL} = 8mA)	-	-	0.6	V		
V _{OH}	Output high voltage (VDD = 2.5 V, I _{OH} = 8mA)	1.8	-	-	V		
I _{DD}	Static supply current *	-	1.1	-	mA		
I _{CC}	Dynamic supply current (2.5V, 24MHz and no load)	-	3.5	-	mA		
VDD	Operating Voltage	2.375	2.5	2.625	V		
t _{ON}	Power-up time (first locked cycle after power-up)	-	-	5	mS		
Z _{OUT}	Output impedance	-	50	-	Ω		
* XIN/CLKIN	* XIN/CLKIN is made low.						

AC Electrical Characteristics for 2.5V Supply

Symbol	Parameter			Тур	Max	Unit	
CLKIN	Input frequency		12	-	30	MHz	
ModOUT	Output frequency		12	-	30	MHz	
f _d	Fraguency Deviation	Input Frequency = 12MHz	-	-	±1.65	%	
	Frequency Deviation Input Free	Input Frequency = 30MHz	-	-	±0.80		
t _{LH} *	Output rise time (measured from 0.7V to 1.7V)		0.7	1.5	1.9	nS	
t _{HL} *	Output fall time (measured from 1.7V to 0.7V)		0.4	1.0	1.1	nS	
t _{JC}	Jitter (cycle to cycle)		-	-	200	pS	
t _D	Output duty cycle	45	50	55	%		
* t_{LH} and t_{HL} are	* t _{LH} and t _{HL} are measured into a capacitive load of 15pF						

DC Electrical Characteristics for 3.3V Supply (Test condition: All parameters are measured at room temperature (+25°C) unless otherwise stated)

Symbol	Parameter	Min	Тур	Max	Unit
VIL	Input low voltage	VSS - 0.3	-	0.8	V
V _{IH}	Input high voltage	2.0	-	VDD + 0.3	V
IIL	Input low current	-	-	-35	μA
I _{IH}	Input high current	-	-	35	μA
I _{XOL}	XOUT output low current (@0.4V, VDD=3.3V)	-	3	-	mA
I _{хон}	XOUT output high current (@2.5V, VDD=3.3V)	-	3	-	mA
V _{OL}	Output low voltage (VDD = 3.3 V, I _{OL} = 8mA)	-	-	0.4	V
V _{OH}	Output high voltage (VDD = 3.3 V, I _{OH} = 8mA)	2.5	-	-	V
I _{DD}	Static supply current*	-	1.2	-	mA
I _{CC}	Dynamic supply current (3.3V, 24MHz and no load)	-	4.0	-	mA
VDD	Operating Voltage	2.7	3.3	3.6	V
t _{ON}	Power-up time (first locked cycle after power-up)	-	-	5	mS
Zout	Output impedance	-	45	-	Ω
* XIN/CLKIN	is made low.				

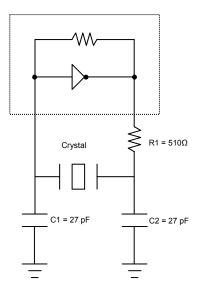
AC Electrical Characteristics for 3.3V Supply

Symbol	Parameter			Тур	Max	Unit	
CLKIN	Input frequency		12	-	30	MHz	
ModOUT	Output frequency		12	-	30	MHz	
f _d	Frequency Deviation	Input Frequency = 12MHz	-	-	±1.65	%	
		Input Frequency = 30MHz	-	-	±0.80		
t _{LH} *	Output rise time (measured from 0.8 to 2.0V)		0.5	1.4	1.7	nS	
t _{HL} *	Output fall time (measured at 2.0V to 0.8V)		0.4	1.0	1.2	nS	
t _{JC}	Jitter (cycle to cycle)			-	200	pS	
t _D	Output duty cycle			50	55	%	
$^{*}t_{\text{LH}}$ and t_{HL} are	*t _{LH} and t _{HL} are measured into a capacitive load of 15pF						



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Typical Crystal Oscillator Circuit



Typical Crystal Specifications

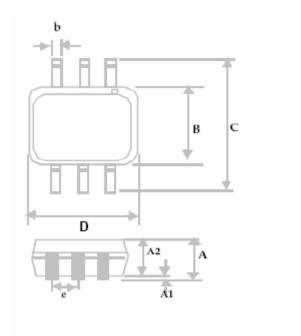
Fundamental AT cut parallel resonant crystal				
Nominal frequency	14.31818MHz			
Frequency tolerance	± 50 ppm or better at 25°C			
Operating temperature range	-25°C to +85°C			
Storage temperature	-40°C to +85°C			
Load capacitance	18pF			
Shunt capacitance	7pF maximum			
ESR	25Ω			

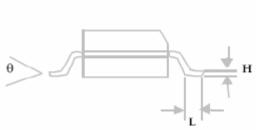


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Package Information

6-pin TSOT-23 Package

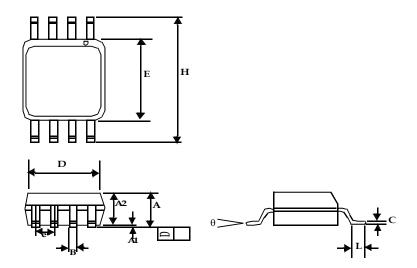




	Dimensions				
Symbol	Inches		Millim	neters	
	Min	Max	Min	Max	
А		0.04		1.00	
A1	0.00	0.004	0.00	0.10	
A2	0.033	0.036	0.84	0.90	
b	0.012	0.02	0.30	0.50	
Н	0.005	5 BSC	0.127	BSC	
D	0.114	BSC	2.90	BSC	
В	0.06	BSC	1.60	BSC	
е	0.0374 BSC		0.950	BSC	
С	0.11 BSC		2.80	BSC	
L	0.0118	0.02	0.30	0.50	
θ	0°	4°	0°	4°	



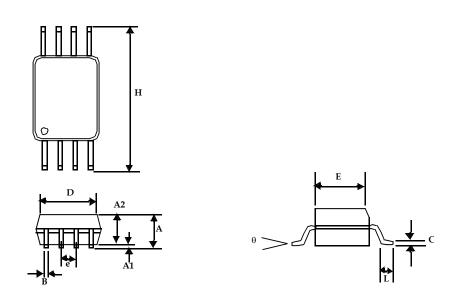
8-Pin SOIC Package



	Dimensions				
Symbol	Inc	hes	Millimeters		
	Min	Мах	Min	Max	
A1	0.004	0.010	0.10	0.25	
А	0.053	0.069	1.35	1.75	
A2	0.049	0.059	1.25	1.50	
В	0.012	0.020	0.31	0.51	
С	0.007	0.010	0.18	0.25	
D	0.193	BSC	4.90	BSC	
E	0.154	BSC	3.91	BSC	
е	0.050 BSC		1.27	BSC	
Н	0.236 BSC		6.00	BSC	
L	0.016	0.050	0.41	1.27	
θ	0°	8°	0°	8°	







	Dimensions				
Symbol	Inches		Millimeters		
	Min	Мах	Min	Max	
А		0.043		1.10	
A1	0.002	0.006	0.05	0.15	
A2	0.033	0.037	0.85	0.95	
В	0.008	0.012	0.19	0.30	
с	0.004	0.008	0.09	0.20	
D	0.114	0.122	2.90	3.10	
E	0.169	0.177	4.30	4.50	
е	0.026 BSC		0.65 BSC		
Н	0.252 BSC		6.40 BSC		
L	0.020	0.028	0.50	0.70	
θ	0°	8°	0°	8°	

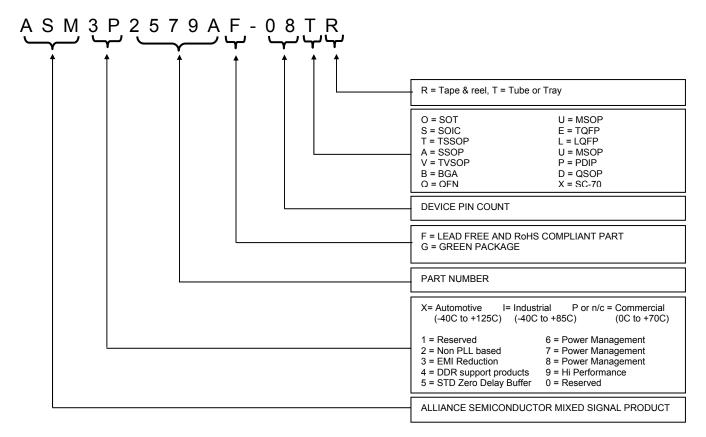


Ordering Information

Part Number	Marking	Package Type	Temperature
ASM3P2579AF-06OR	S4LL	6-Pin TSOT-23, TAPE & REEL, Pb Free	Commercial
ASM3P2579AF-08TT	3P2579AF	8-Pin TSSOP, TUBE, Pb Free	Commercial
ASM3P2579AF-08TR	3P2579AF	8-Pin TSSOP, TAPE & REEL, Pb Free	Commercial
ASM3P2579AF-08ST	3P2579AF	8-Pin SOIC, TUBE, Pb Free	Commercial
ASM3P2579AF-08SR	3P2579AF	8-Pin SOIC, TAPE & REEL, Pb Free	Commercial
ASM3P2579A-06OR	S1LL	6-Pin TSOT-23, TAPE & REEL	Commercial
ASM3P2579A-08TT	3P2579A	8-Pin TSSOP, TUBE	Commercial
ASM3P2579A-08TR	3P2579A	8-Pin TSSOP, TAPE & REEL	Commercial
ASM3P2579A-08ST	3P2579A	8-Pin SOIC, TUBE	Commercial
ASM3P2579A-08SR	3P2579A	8-Pin SOIC, TAPE & REEL	Commercial
ASM3P2579AG-06OR	S3LL	6-Pin TSOT-23, TAPE & REEL, Green	Commercial
ASM3P2579AG-08TT	3P2579AG	8-Pin TSSOP, TUBE, Green	Commercial
ASM3P2579AG-08TR	3P2579AG	8-Pin TSSOP, TAPE & REEL, Green	Commercial
ASM3P2579AG-08ST	3P2579AG	8-Pin SOIC, TUBE, Green	Commercial
ASM3P2579AG-08SR	3P2579AG	8-Pin SOIC, TAPE & REEL, Green	Commercial
ASM3I2579AF-06OR	S5LL	6-Pin TSOT-23, TAPE & REEL, Pb Free	Industrial
ASM3I2579AF-08TT	3I2579AF	8-Pin TSSOP, TUBE, Pb Free	Industrial
ASM3I2579AF-08TR	3I2579AF	8-Pin TSSOP, TAPE & REEL, Pb Free	Industrial
ASM3I2579AF-08ST	3I2579AF	8-Pin SOIC, TUBE, Pb Free	Industrial
ASM3I2579AF-08SR	3I2579AF	8-Pin SOIC, TAPE & REEL, Pb Free	Industrial
ASM3I2579A-06OR	S2LL	6-Pin TSOT-23, TAPE & REEL	Industrial
ASM3I2579A-08TT	3I2579A	8-Pin TSSOP, TUBE	Industrial
ASM3I2579A-08TR	3I2579A	8-Pin TSSOP, TAPE & REEL	Industrial
ASM3I2579A-08ST	3I2579A	8-Pin SOIC, TUBE	Industrial
ASM3I2579A-08SR	3I2579A	8-Pin SOIC, TAPE & REEL	Industrial
ASM312579AG-06OR	S6LL	6-Pin TSOT-23, TAPE & REEL, Green	Industrial
ASM3I2579AG-08TT	3I2579AG	8-Pin TSSOP, TUBE, Green	Industrial
ASM3I2579AG-08TR	3l2579AG	8-Pin TSSOP, TAPE & REEL, Green	Industrial
ASM3I2579AG-08ST	3I2579AG	8-Pin SOIC, TUBE, Green	Industrial
ASM312579AG-08SR	3l2579AG	8-Pin SOIC, TAPE & REEL, Green	Industrial

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Device Ordering Information



Licensed under U.S Patent Nos 5,488,627 and 5,631,921



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Note: This product utilizes US Patent # 6,646,463 Impedance Emulator Patent issued to Alliance Semiconductor, dated 11-11-2003

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